FABRICATION NOTES:
1. ALL BOARD DIMENSIONS IN INCHES. TOLERANCE = +/-0.005" UNLESS NOTED OTHERWISE.
2. BOARD TO BE FABRICATED TO IPC-A-600, CURRENT REVISION.
   SPECIFICATIONS LISTED HERE SUPERCEDE APPLICABLE IPC SPECIFICATIONS.
3. BOARD MATERIAL — FR-4 GRADE CLASS EPOXY, 0.065" +0.003"/-0.004" THICKNESS MEASURED OVER COPPER
   MINIMUM FLAMMABILITY RATING UL 94V-0
4. OUTER LAYER FINISHED COPPER THICKNESS 0.0028" (2 OZ).
   INNER LAYER COPPER THICKNESS 0.0014" (1 OZ).
5. SOLDER MASK OVER BARE COPPER, LPI, CLASS 2 GEN. INDUSTRIAL REGISTRATION +/-0.004", CLEAR.
   NO COVERAGE ON SOLDER PADS PERMITTED.
6. FINISH-TIN/LEAD REFLOWED OR HOT AIR SOLDER LEVELED-0.0002" TO 0.002" PLATING THICKNESS.
   NO EXPOSED BARE COPPER PERMITTED.
7. SILKSCREEN WHITE EPOXY NON-CONDUCTIVE INK OVER GREEN SOLDERMASK, TOP SIDE ONLY.
   SILKSCREEN SHOULD BE TRIMMED OFF ANY SOLDERED ENTITY.
8. HOLE CENTERS AND PAD CENTERS TO BE CONCENTRIC WITHIN 0.005"

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DRILL CHART

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</table>

ARTWORK/FABRICATION FILES
LAYER 1 — TOP SIDE ROUTING — COPPER1.PHO
LAYER 2 — INNER 2 ROUTING — COPPER2.PHO
LAYER 3 — INNER 3 ROUTING — COPPER3.PHO
LAYER 4 — BOTTOM SIDE ROUTING — COPPER4.PHO
TOP SIDE SOLDERMASK — TOPMASK.PHO
BOTTOM SIDE SOLDERMASK — BOTTOMMASK.PHO
TOP SIDE SILKSCREEN — TOPSILK.PHO
NC DRILL FILE — NCDRILL.DBL
APERTURE LIST — APERTURES.REP

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5010 CUMBERLAND DRIVE
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PHONE: (513) 773-4602 FAX: (513) 775-0731

DRAWN BY:
DS/MA
DATE: 01/01/2004

DRAFTER:
MARK WOBSKI
DATE: 01/01/2004

SD:
TEXO3PAB

PAGE 1 OF 1
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